### M. TALMIZ UR REHMAN

## Embedded Firmware Developer | Hardware Firmware Integration Specialist

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## Summary

Embedded firmware engineer with 2 years of hands-on experience in firmware development and hardware integration, specializing in Qualcomm QCM6125 platform and advanced PCB design. Successfully led firmware development initiatives that enabled seamless integration of display, touch, and camera modules, and significantly improved reverse wireless charging performance through precise impedance tuning.

### Experience

AIO APP Inc Islamabad, Pakistan

### Hardware Design Engineer

11/2023 - Present ocessor, enabling seamless

- Firmware Development— Quectel SC668S Platform: Spearheaded firmware development on the Qualcomm QCM6125 processor, enabling seamless integration of various hardware modules. Focused on system-level coordination, stability, and feature optimization across the device architecture. Worked with QNavigator, QFlash, and QPST for module setup, firmware flashing.
- Display, Touch & Camera Integration: Led firmware bring-up and tuning for display, touch, and camera modules. Calibrated touch sensitivity, display brightness, and camera interfacing to ensure responsiveness and reliability across different usage scenarios.
- Power Management, Fast Charging & Thermal Safety: Integrated battery calibration logic and charging ICs with the Quectel SC668S SOM to support fast-charging protocols. Optimized reverse wireless charging through impedance tuning and firmware-based power control. Assessed thermal behavior and implemented safety features, including thermal cutoffs and automatic charge termination on overheating.
- High-Speed Flex and Multilayer PCB Design: Researched and designed high-speed flex and multilayer PCBs with optimized signal integrity for main-to-daughterboard and peripheral connections. Assessed EMI control, differential pair routing, and power delivery for reliable audio, display, and data performance. Developed flex interposers for early firmware testing on Quectel EVB.

AIO APP Inc

Shenzhen, China

#### International Engineering Visit—China

03/2025 - 04/2025

- Optimized key peripherals (display, touch, battery, speaker, MIC) for power, performance, and integration. Tuned display brightness vs. power draw, calibrated touch sensitivity, refined battery specs, verified speaker acoustic tuning, and implemented MIC noise cancellation with beam forming.
- Led critical testing: antenna tuning (2.4/5 GHz), FCC (EMI/EMC, ESD, OTA), vibration, drop, USB, and thermal profiling with 8-probe monitoring and firmware shutdown thresholds.
- Oversaw SMT: verified footprints, reflow soldering, X-ray, AOI, and dye testing for BGA parts. Flashed firmware, validated system functionality, manufactured and completed product shipment.

TeReSol Pvt. Ltd Islamabad, Pakistan

#### Hardware Design Engineer

08/2023 - 11/2023

- Embedded design and development using C/C++
- Developed Bash/Shell Scripts for Process Automation
- Bug tracing and Fixing to enable a Functional Firmware
- Cloning and Flashing of customized Nvidia Tegra GPU cards

#### Education

## COMSATS University Islamabad

Islamabad, Pakistan

Bachelor of Science Electrical (Computer) Engineering

09/2019 - 09/2023

#### Skills

Programming Languages: Embedded C, C++, Python, Bash/Shell, Verilog, ARM Assembly

Tools: Arduino, ESP32, Raspberry Pi, FPGA, QCM6125, Communication Protocols (I2c, SPI, UART)

Softwares: Altium, EasyEDA, Proteus, MATLAB, Embedded Linux, Ubuntu, RTOS, Git

# Projects

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Table Side AI Device		11/2023 - Present
Design and Development of Table Side AI Devi	ice	
<ul> <li>Developed system firmware on Qu interaction.</li> </ul>	ectel SC668S SOM, integrating display, touch, and camera modules for real-time	
-	t, fast charging, and reverse wireless charging control logic.  speed PCBs with signal integrity and EMI control.	
		08/2023 - 11/2023
Semi-Autonomous Object Tracki	ing Sentry Robot (FYP)	
Development of a semi-autonomous object tr	acking system	
<ul> <li>Design and development of Detect</li> <li>Improved tracking efficiency by into</li> <li>Double Layer PCB Design and Fabri</li> </ul>	egrating Raspberry PI units with Python for seamless operations	
laces Consolution wine EDCA		06/2022 - 09/2022
Image Convolution using FPGA		
Image Convolution using FPGA	planing and implementing actimized algorithms using Variles on Viling FDCA	
Displayed original and resultant Im	eloping and implementing optimized algorithms using Verilog on Xilinx FPGA.  age using VGA.	
		06/2022 - 09/2022
Line Following, Sumo and Obsta	cle Avoider Robot	00/2022 - 09/2022
Line Following, Sumo and Obstacle Avoider Ro	bbot	
= :	ollowing, Sumo and Obstacle Avoider Robot using Arduino eloping an interactive Sumo Robot app using MIT • Double Layer PCB as a chassis of	
	Awards	
Microwiz Winner Visospark '23 COMSATS	Leadership Excellence Award  IEEE SAC Leadership Dialogue 2022  HI ROBO TEC, T	_
	Interests	
Sports	Adventure	
Table Tennis, Badminton	Traveling, Photography	
	Certification	
Advanced Embedded Linux Developme	ent Specialization — Coursera	
Internet of Things IOT, Robotics and Ha	cking with NodeMCU — Udemy	
Mastering Linux: The Complete Guide t	to Becoming a Linux Pro — Udemy	
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